



Click [here](#) for the 3D model.

### Dimensions

Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.15mm
B	0.3mm +/-0.2mm

### Packaging Specifications

Packaging	T&R
Packaging Quantity	4000

### General Information

Series	Z-SMS
Style	SMD Chip
Description	Chip Bead Signal Line
Features	Suppresses The XL Component; Helps Stop The Reduction Of The Wave-Form Integrity
RoHS	Yes
Notes	Suggested Replacement - <a href="https://productfinder.pulseelectronics.com/part/BBGK00160808601Y00">https://productfinder.pulseelectronics.com/part/BBGK00160808601Y00</a> .

### Specifications

Impedance	600 Ohms (100 MHz)
Impedance Tolerance	25%
Ripple Current	350 mA (MAX)
Temperature Range	-55/+125°C